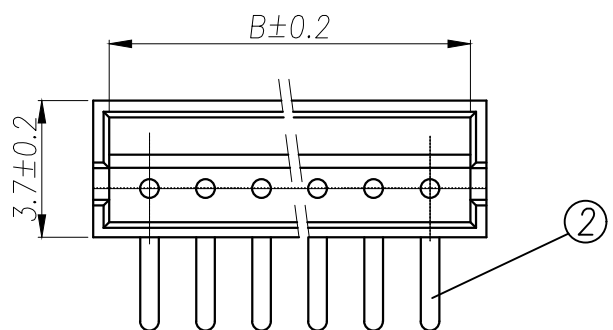
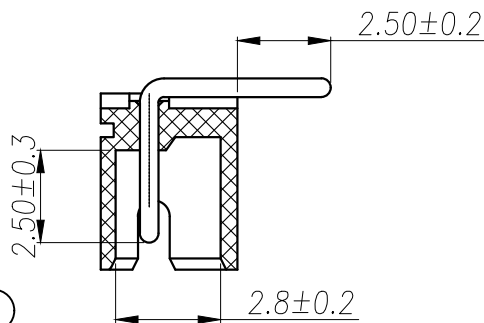
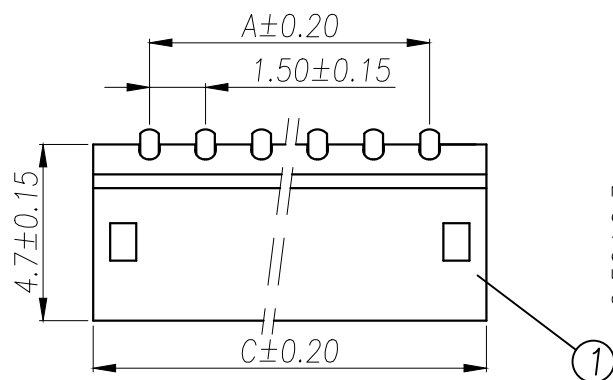


PRELIMINARY
DESIGN IS SUBJECT
TO CHANGE WITHOUT
PRIOR NOTICE



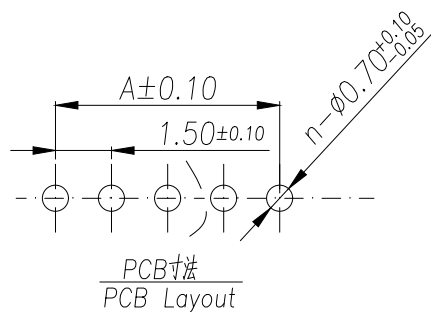
ROHS管理规定:

1. 禁止使用含有ROHS指令所限制的物质。
2. 对应的SGS或ITS出具的ICP-AES数据, 不可测定物质的成分表, 有效期一年。

技术指标:

1. 塑件表面应光洁, 无毛刺, 明显收缩, 缺陷, 裂纹等现象;
2. 温度范围: $-25^{\circ}\text{C}\sim 85^{\circ}\text{C}$;
3. 额定电压: 250V AC, DC(等效);
4. 接触电阻: $\leq 0.03\text{m}\Omega$;
5. 绝缘电阻: $\geq 1000\text{M}\Omega$;
6. 耐压: 1000V AC/minute.

Part No	PIN	A	B	C
XY-ZH1.5-2PWZ	2	1.5	3.6	4.5
XY-ZH1.5-3PWZ	3	3	5.1	6
XY-ZH1.5-4PWZ	4	4.5	6.6	7.5
XY-ZH1.5-5PWZ	5	6	8.1	9
XY-ZH1.5-6PWZ	6	7.5	9.6	10.5
XY-ZH1.5-7PWZ	7	9	11.1	12
XY-ZH1.5-8PWZ	8	10.5	12.6	13.5
XY-ZH1.5-9PWZ	9	12	14.1	15
XY-ZH1.5-10PWZ	10	13.5	15.6	16.5
XY-ZH1.5-11PWZ	11	15	17.1	18
XY-ZH1.5-12PWZ	12	16.5	18.6	19.5
XY-ZH1.5-13PWZ	13	18	20.1	21
XY-ZH1.5-14PWZ	14	19.5	21.6	22.5
XY-ZH1.5-15PWZ	15	21	23.1	24
XY-ZH1.5-16PWZ	16	22.5	24.6	25.5



2	Contact	Brass	n*1	电镀(锡): 整个表面镀底镍30u"MIN,再镀锡80u"MIN.
1	Wafer	PA66(UL94V-0)	1	白色
序号	名称	材料	数量	附注
DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyeconn Electronics Co.,Ltd		
TOLERANCE UNLESS OTHERWISE SPECIFIED				
.X±0.35	.X°± 5°	APR. Alex	TITLE: WAFER 1.5mm H4.9mm 90°DIP	
.XX±0.25	.X°± 3°	CHK. Jack	DWG NO. XY-ZH1.5-NPWZ	
.XXX±0.15	.XX°± 1°	DRA. Can	PROJ. 	CUSTOMER DRAWING
			SIZE A4	SCALE 1:1